PAL16L8AM, PAL16L8A-2M, PAL16R4AM, PAL16R4A-2M PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

- Choice of Operating Speeds High-Speed, A Devices . . . 25 MHz Min Half-Power, A-2 Devices . . . 16 MHz Min
- Choice of Input/Output Configuration
- Package Options Include Both Ceramic DIP and Chip Carrier in Addition to Ceramic Flat Package

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORT S
PAL16L8	10	2	2 0	
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

description

These programmable array logic devices feature high speed and a choice of either standard or half-power devices. They combine Advanced Low-Power Schottky technology with proven titanium-tungsten fuses. These devices will provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allow for quick design of "custom" functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

The Half-Power versions offer a choice of operating frequency, switching speeds, and power dissipation. In many cases, these Half-Power devices can result in significant power reduction from an overall system level.

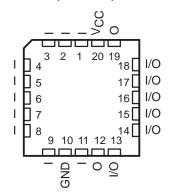
The PAL16' M series is characterized for operation over the full military temperature range of -55° C to 125° C.

PAL16L8'
J OR W PACKAGE
(TOP VIEW)

1	-			
١C	1	U	20]v _{cc}
ι[2		19]0
1 [3		18] I/O
1 [4		17] 1/0
ΙC	5		16] 1/0
١C	6		15] I/O
ΙC	7		14] I/O
١Ľ	8		13] I/O
ΙC	9		12]0
GND [10		11	ון
l				I

PAL16L8' FK PACKAGE



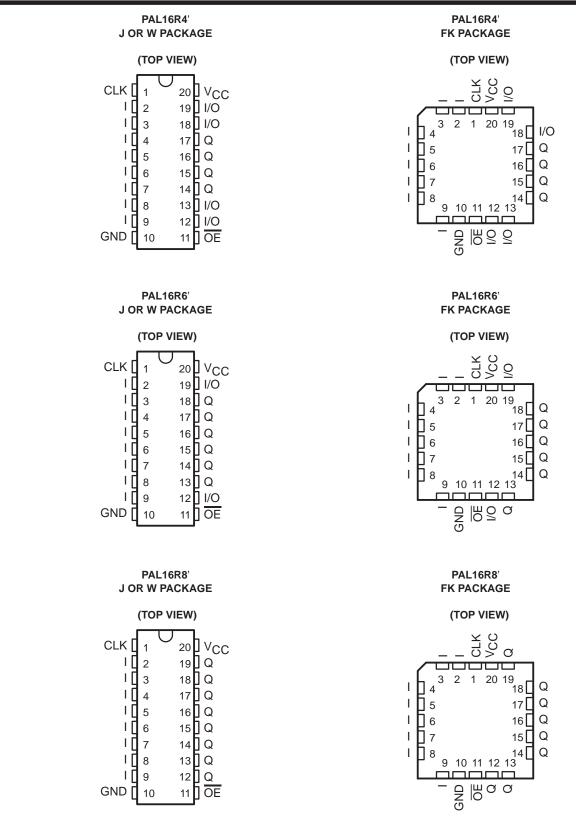


PAL is a registered trademark of Advanced Micro Devices Inc.



PAL16R4AM, PAL16R4A-2M, PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED $\it PAL^{\textcircled{B}}$ CIRCUITS

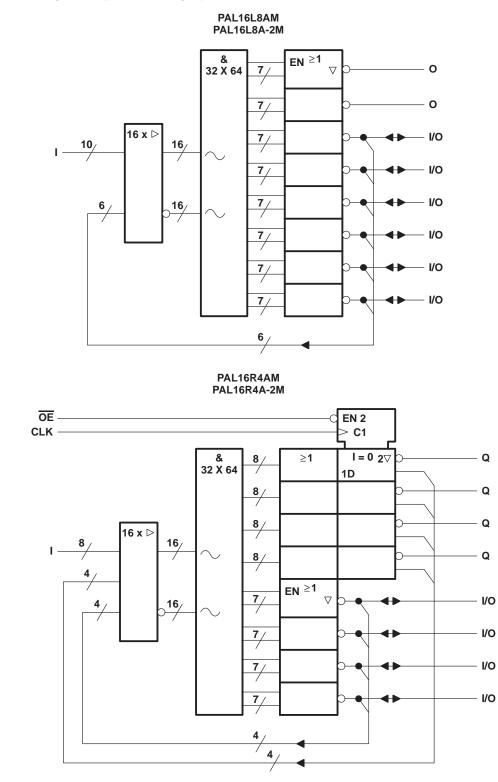
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PAL16L8AM, PAL16L8A-2M, PAL16R4AM, PAL16R4A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

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functional block diagrams (positive logic)

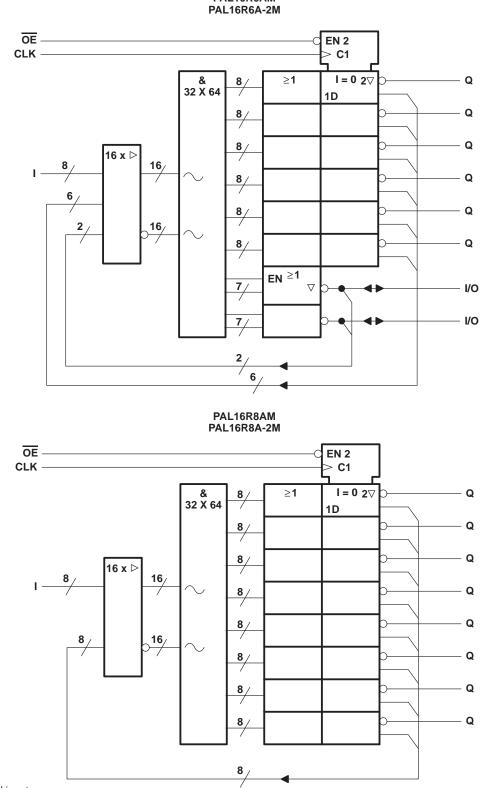
 \sim denotes fused inputs



PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

SRPS016 - D2705, FEBRUARY 1984 - REVISED MARCH 1992

functional block diagrams (positive logic)



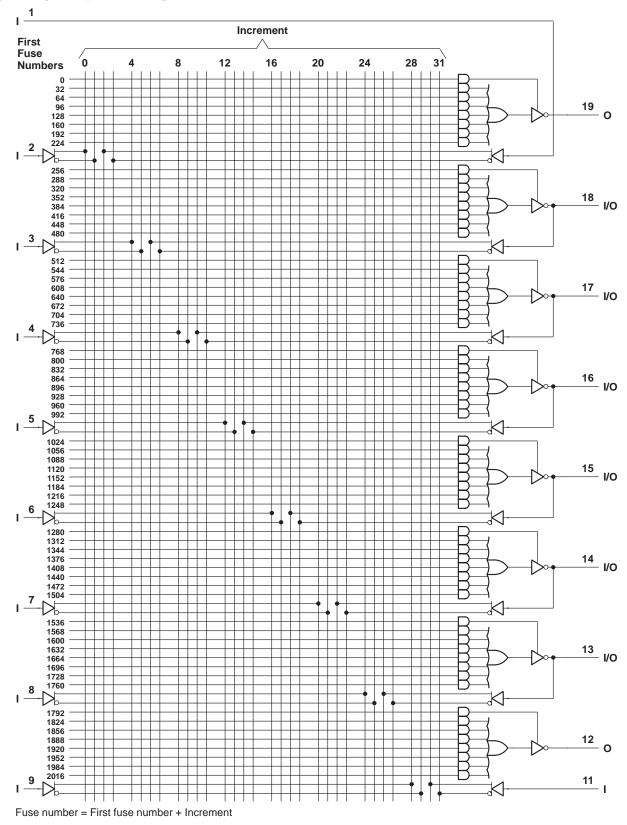
PAL16R6AM

 \bigcirc denotes fused inputs



PAL16L8AM, PAL16L8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

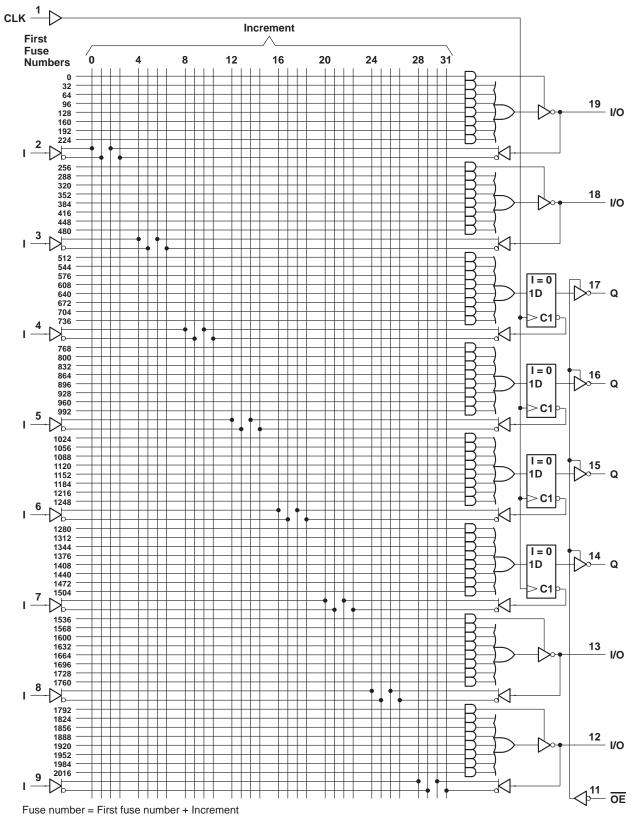
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PAL16R4AM, PAL16R4A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

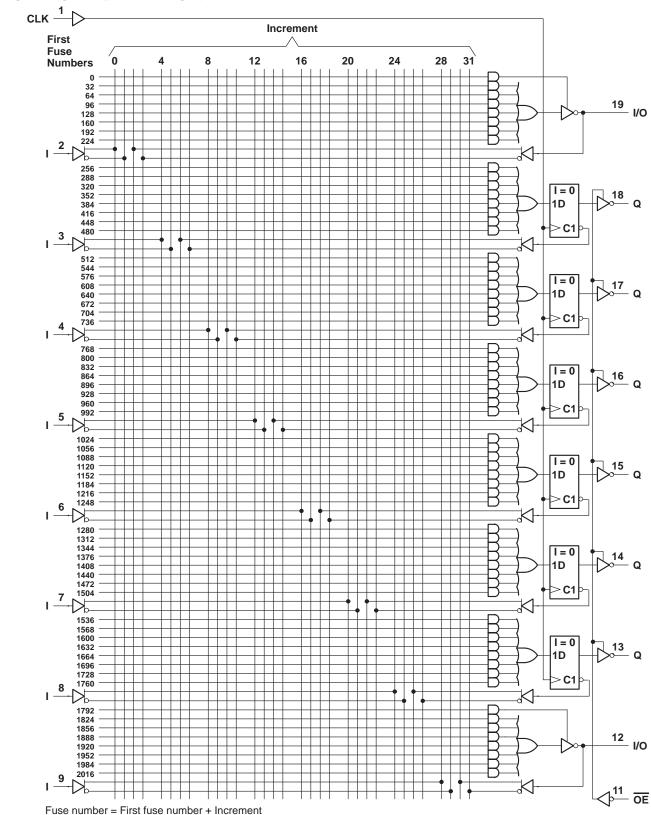
SRPS016 - D2705, FEBRUARY 1984 - REVISED MARCH 1992





PAL16R6AM, PAL16R6A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

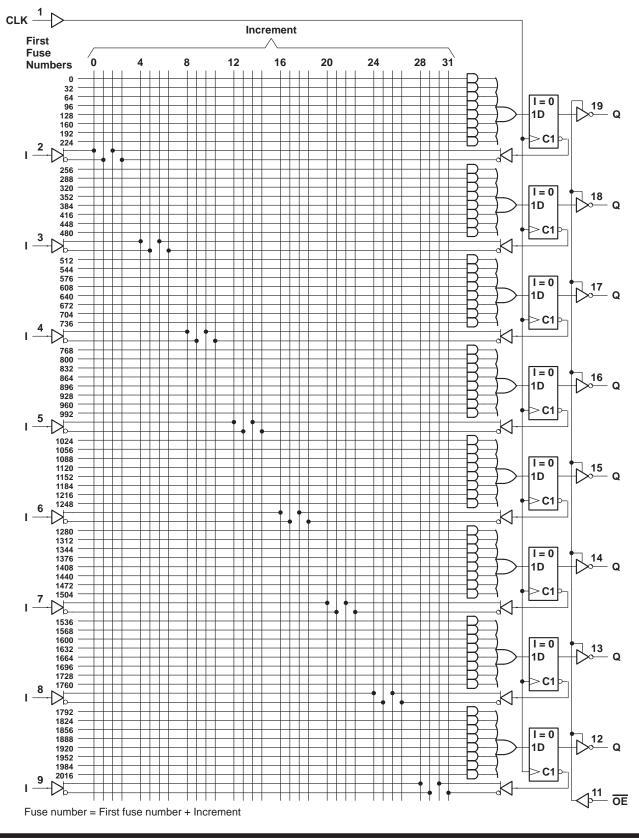
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PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

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PAL16L8AM, PAL16L8A-2M, PAL16R4AM, PAL16R4A-2M PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

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programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	C to 125°C
Storage temperature range	C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2		5.5	V
VIL	Low-level input voltage			0.8	V
ЮН	High-level output current			-2	mA
IOL	Low-level output current			12	mA
TA	Operating free-air temperature	-55	25	125	°C



PAL16L8AM, PAL16R4AM, PAL16R6AM, PAL16R8AM STANDARD HIGH-SPEED PAL® CIRCUITS

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electrical characteristics over recommended operating free-air temperature range

PAR	RAMETER		TEST CONDITIONS	6	MIN	TYP [†]	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lj = -18 mA				-1.5	V
VOH		V _{CC} = 4.5 V,	$I_{OH} = -2 \text{ mA}$		2.4	3.2		V
VOL		V _{CC} = 4.5 V,	I _{OL} = 12 mA			0.25	0.4	V
	Outputs						20	
IOZH	I/O ports	V _{CC} = 5.5 V,	V _O = 2.7 V				100	μA
	Outputs						-20	
IOZL	I/O ports	V _{CC} = 5.5 V,	$V_{O} = 0.4 V$				-100	μA
lj –		V _{CC} = 5.5 V,	V _I = 5.5 V				0.2	mA
lu i	I/O Ports						100	
ΙΗ	All others	V _{CC} = 5.5 V,	V _I = 2.7 V				25	μA
	OE input						-0.2	
μL	All others	V _{CC} = 5.5 V,	$V_{I} = 0.4 V$				-0.1	mA
los‡		V _{CC} = 5.5 V,	V _O = 0.5 V		-30		-250	mA
ICC		V _{CC} = 5.5 V,	$V_{I} = 0,$	Outputs open		75	180	mA

timing requirements

			MIN	MAX	UNIT
fclock	Clock Frequency		0	25	MHz
		Clock high	15		
τ _w	Pulse duration (see Note 2)	Clock low	20		ns
t _{su}	Setup time, input or feedback before CLK [↑]		25		ns
th	Hold time, input or feedback after CLK [↑]		0		ns

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock}. The minimum pulse durations specified are only for clock high or low, but not for both simultaneously.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	түр†	MAX	UNIT
fmax				25	45		MHz
^t pd	I, I/O	0, I/O			15	30	ns
^t pd	CLK↑	Q	R1 = 390 Ω,		10	20	ns
ten	OE↓	Q	R2 = 750 Ω,		15	25	ns
^t dis	OE↑	Q	See Figure 1		10	25	ns
t _{en}	I, I/O	O, I/O]		14	30	ns
^t dis	I, I/O	O, I/O			13	30	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.



PAL16L8A-2M, PAL16R4A-2M, PAL16R6A-2M, PAL16R8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

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electrical characteristics over recommended operating free-air temperature range

PAR	RAMETER		TEST CONDITION	S	MIN	TYP [†]	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lj = -18 mA				-1.5	V
VOH		V _{CC} = 4.5 V,	$I_{OH} = -2 \text{ mA}$		2.4	3.2		V
VOL		V _{CC} = 4.5 V,	I _{OL} = 12 mA			0.25	0.4	V
1	Outputs						20	
IOZH	I/O ports	V _{CC} = 5.5 V,	$V_{O} = 2.7 V$				100	μA
	Outputs						-20	
IOZL	I/O ports	V _{CC} = 5.5 V,	$V_{O} = 0.4 V$				-100	μA
Ιį	-	V _{CC} = 5.5 V,	V _I = 5.5 V				0.2	mA
L	I/O Ports						100	
Iн	All others	V _{CC} = 5.5 V,	V _I = 2.7 V				25	μA
	OE input		N/ 0.4 M				-0.2	
ΙL	All others	V _{CC} = 5.5 V,	$V_{I} = 0.4 V$				-0.1	mA
los‡	-	V _{CC} = 5.5 V,	V _O = 0.5 V		-30		-250	mA
ICC		V _{CC} = 5.5 V,	$V_{I} = 0,$	Outputs open		75	90	mA

timing requirements

			MIN	MAX	UNIT
fclock	Clock Frequency		0	16	MHz
		Clock high	25		
tw	Pulse duration (see Note 2)	Clock low	25		ns
t _{su}	Setup time, input or feedback before $CLK\uparrow$	-	35		ns
th	Hold time, input or feedback after $CLK\uparrow$		0		ns

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock}. The minimum pulse durations specified are only for clock high or low, but not for both simultaneously.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	түр†	MAX	UNIT
fmax				16	25		MHz
^t pd	I, I/O	0, I/O]		25	40	ns
^t pd	CLK↑	Q	R1 = 390 Ω,		11	25	ns
ten	OE↓	Q	R2 = 750 Ω,		20	25	ns
^t dis	OE↑	Q	See Figure 1		11	25	ns
t _{en}	I, I/O	O, I/O]		25	40	ns
^t dis	I, I/O	O, I/O			25	35	ns

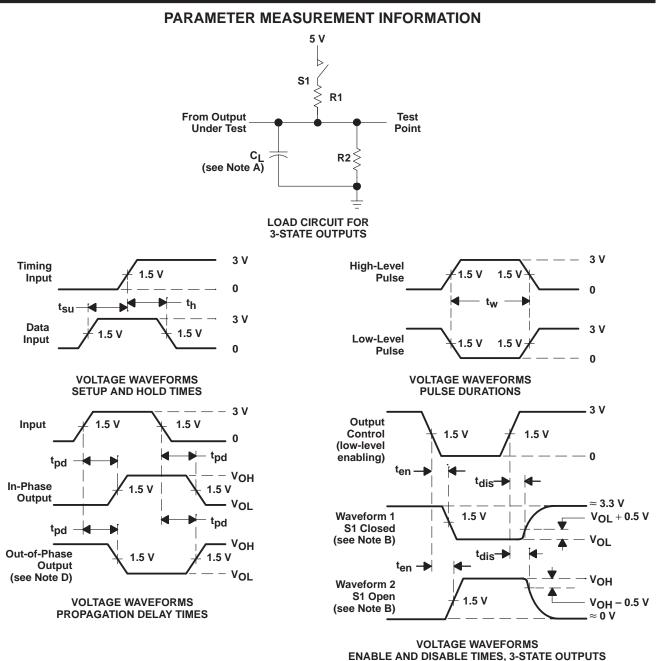
[†] All typical values are at V_{CC} = 5 V, $T_A = 25^{\circ}$ C.

[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.



PAL16L8AM, PAL16L8A-2M, PAL16R4AM, PAL16R4A-2M PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED *PAL*[®] CIRCUITS

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- NOTES: A. CL includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses have the following characteristics: PRR \leq 10 MHz, t_r and t_f \leq 2 ns, duty cycle = 50%
 - D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
 - E. Equivalent loads may be used for testing.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
81036072A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036072A PAL16L8A MFKB
8103607RA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103607RA PAL16L8AMJB
8103607SA	Active	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103607SA PAL16L8AMWB
81036082A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036082A PAL16R8A MFKB
8103608RA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103608RA PAL16R8AMJB
81036092A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036092A PAL16R6A MFKB
8103609RA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103609RA PAL16R6AMJB
81036102A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036102A PAL16R4A MFKB
8103610RA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103610RA PAL16R4AMJB
8103610SA	Active	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103610SA PAL16R4AMWB
81036112A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036112A PAL16L8A- 2MFKB
8103611RA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103611RA PAL16L8A-2MJB
81036142A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036142A PAL16R4A- 2MFKB



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PACKAGE OPTION ADDENDUM

2-May-2025

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
PAL16L8A-2MFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036112A PAL16L8A- 2MFKB
PAL16L8A-2MJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16L8A-2MJ
PAL16L8A-2MJB	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103611RA PAL16L8A-2MJB
PAL16L8AMFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036072A PAL16L8A MFKB
PAL16L8AMJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16L8AMJ
PAL16L8AMJB	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103607RA PAL16L8AMJB
PAL16L8AMWB	Active	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103607SA PAL16L8AMWB
PAL16R4A-2MFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036142A PAL16R4A- 2MFKB
PAL16R4A-2MJ	NRND	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16R4A-2MJ
PAL16R4AMFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036102A PAL16R4A MFKB
PAL16R4AMJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16R4AMJ
PAL16R4AMJB	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103610RA PAL16R4AMJB
PAL16R4AMWB	Active	Production	CFP (W) 20	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103610SA PAL16R4AMWB
PAL16R6AMFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036092A PAL16R6A MFKB
PAL16R6AMJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16R6AMJ
PAL16R6AMJB	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103609RA PAL16R6AMJB
PAL16R8AMFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	81036082A PAL16R8A MFKB



Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
PAL16R8AMJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	PAL16R8AMJ
PAL16R8AMJB	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8103608RA PAL16R8AMJB

⁽¹⁾ **Status:** For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF PAL16L8A-2M, PAL16L8AM, PAL16R4AM, PAL16R6AM, PAL16R8AM :

• Catalog : PAL16L8A-2, PAL16L8A, PAL16R4A, PAL16R6A, PAL16R8A

NOTE: Qualified Version Definitions:



• Catalog - TI's standard catalog product

TEXAS INSTRUMENTS

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5-Dec-2023

TUBE



- B - Alignment groove width

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
81036072A	FK	LCCC	20	55	506.98	12.06	2030	NA
8103607SA	W	CFP	20	25	506.98	26.16	6220	NA
81036082A	FK	LCCC	20	55	506.98	12.06	2030	NA
81036092A	FK	LCCC	20	55	506.98	12.06	2030	NA
81036102A	FK	LCCC	20	55	506.98	12.06	2030	NA
8103610SA	W	CFP	20	25	506.98	26.16	6220	NA
81036112A	FK	LCCC	20	55	506.98	12.06	2030	NA
81036142A	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16L8A-2MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16L8AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16L8AMWB	W	CFP	20	25	506.98	26.16	6220	NA
PAL16R4A-2MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16R4AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16R4AMWB	W	CFP	20	25	506.98	26.16	6220	NA
PAL16R6AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
PAL16R8AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA

FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice. В.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification only.
 E. Falls within Mil-Std 1835 GDFP2-F20



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